SN74BCT533 OCTAL TRANSPARENT D-TYPE LATCH WITH 3-STATE OUTPUTS

SCBS055A - JULY 1990 - REVISED NOVEMBER 1993

- State-of-the-Art BiCMOS Design Significantly Reduces I_{CCZ}
- Full Parallel Access for Loading
- 3-State Inverting Outputs Drive Bus Lines or Buffer Memory Address Registers
- ESD Protection Exceeds 2000 V Per MIL-Std-883C, Method 3015
- Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic 300-mil DIPs (N)

(TOP VIEW) 20 | V_CC OE 19 8Q 1Q 2 1D 🛮 3 18 8D 2D 🛮 4 17 🛮 7D 2Q 🛮 5 16 7 7 Q 3Q [] 6 15 6Q 3D 🛮 7 14 ¶ 6D 4D Π 8 13 5D 4Q 9 12 5Q GND [] 10 11 🛮 LE

DW OR N PACKAGE

description

The SN74BCT533 is an 8-bit transparent D-type latch with 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. It is particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

When the latch-enable (LE) input is high, the \overline{Q} outputs follow the complements of the data (D) inputs. When LE is taken low, the \overline{Q} outputs are latched at the inverse of the levels set up at the D inputs. The SN74BCT533 provides inverted data at its outputs.

A buffered output-enable (\overline{OE}) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and the increased drive provide the capability to drive bus lines without need for interface or pullup components.

The output-enable (\overline{OE}) input does not affect the internal operations of the latch. Previously stored data can be retained or new data can be entered while the outputs are in the high-impedance state.

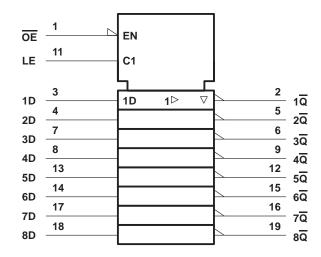
The SN74BCT533 is characterized for operation from 0°C to 70°C.

FUNCTION TABLE (each latch)

	INPUTS	OUTPUT	
OE	LE	D	Q
L	Н	Н	L
L	Н	L	Н
L	L	Χ	\overline{Q}_0
Н	Χ	Χ	Z

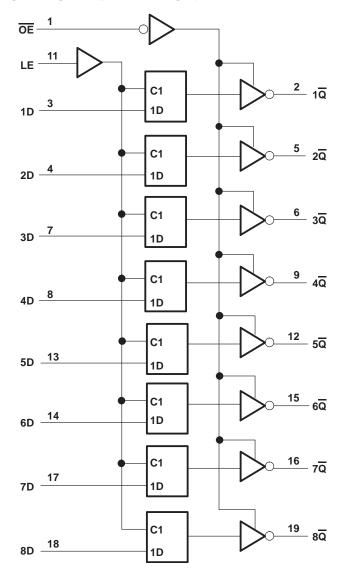
SCBS055A - JULY 1990 - REVISED NOVEMBER 1993

logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



SN74BCT533 OCTAL TRANSPARENT D-TYPE LATCH WITH 3-STATE OUTPUTS SCBS055A - JULY 1990 - REVISED NOVEMBER 1993

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	– 0.5 V to 7 V
Input voltage range, V _I (see Note 1)	0.5 V to 7 V
Voltage range applied to any output in the disabled or power-off state, V _O	– 0.5 V to 7 V
Voltage range applied to any output in the high state, V _O	\dots – 0.5 V to V _{CC}
Input clamp current	–30 mA
Current into any output in the low state	128 mA
Operating free-air temperature range	0°C to 70°C
Storage temperature range	– 65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

recommended operating conditions

		MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2			V
VIL	Low-level input voltage			8.0	V
ΙΙΚ	Input clamp current			-18	mA
lOH	High-level output current			-15	mA
loL	Low-level output current			64	mA
T _A	Operating free-air temperature	0		70	°C

SN74BCT533 OCTAL TRANSPARENT D-TYPE LATCH WITH 3-STATE OUTPUTS

SCBS055A - JULY 1990 - REVISED NOVEMBER 1993

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP [†]	MAX	UNIT
VIK	$V_{CC} = 4.5 \text{ V},$	I _I = -18 mA			-1.2	V
	V 45V	$I_{OH} = -3 \text{ mA}$	2.4	3.3		
VOH	V _{CC} = 4.5 V	$I_{OH} = -15 \text{ mA}$	2	3.1		V
	$V_{CC} = 4.75 \text{ V},$	I _{OH} = -3 mA	2.7			
V _{OL}	V _{CC} = 4.5 V,	I _{OL} = 64 mA		0.42	0.55	V
l _l	$V_{CC} = 5.5 \text{ V},$	V _I = 5.5 V			0.4	mA
lін	V _{CC} = 5.5 V,	V _I = 2.7 V			20	μΑ
I _{IL}	V _{CC} = 5.5 V,	V _I = 0.5 V			-0.6	mA
los [‡]	V _{CC} = 5.5 V,	VO = 0	-100		-225	mA
lozh	V _{CC} = 5.5 V,	V _O = 2.7 V			50	μΑ
lozL	V _{CC} = 5.5 V,	V _O = 0.5 V			-50	μΑ
^I CCL	V _{CC} = 5.5 V			40	63	mA
Iссн	V _{CC} = 5.5 V			5	8	mA
ICCZ	V _{CC} = 5.5 V			5	8	mA
C _i	V _{CC} = 5 V,	V _I = 2.5 V or 0.5 V		6		рF
Co	V _{CC} = 5 V,	V _O = 2.5 V or 0.5 V		11		рF

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

		V _{CC} = 5 V, T _A = 25°C MIN MAX		UNIT	
			MIN MA	AX	
t _W	t _w Pulse duration, LE high		4	4	ns
t _{su}	Setup time, data before LE↓	High or low	2.5	2.5	ns
t _h	Hold time, data after LE \downarrow	High or low	3	3	ns

[‡] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

switching characteristics (see Note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C _I R ₁ T ₂	CC = 5 V = 50 pt = 500 st = 500 st = 25°C	F, Ω, Ω,	C _L = 50 p R ₁ = 500 s R ₂ = 500 s T _A = MIN	Ω, Ω, to MAX†	UNIT
			MIN	TYP	MAX	MIN	MAX	
^t PLH	D	Q	2.8	6.1	9.1	2.8	11.2	
^t PHL	D	Q	2.7	5.3	8.2	2.7	9.3	ns
^t PLH		Ια	2.3	5	7.7	2.3	8.6	
^t PHL	LE	Q	2.5	4.9	7.6	2.5	8.1	ns
^t PZH		-	3.1	6.1	8.8	3.1	10.8	
t _{PZL}	ŌĒ	₫	3.7	6.9	10	3.7	12	ns
^t PHZ	ŌĒ	Ια	1.8	3.9	5.9	1.8	6.9	
t _{PLZ}	OE OE	Q	1.3	3.5	6.1	1.3	7.2	ns

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



PACKAGE OPTION ADDENDUM

18-Sep-2008

PACKAGING INFORMATION

www ti com

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74BCT533DW	OBSOLETE	SOIC	DW	20	TBD	Call TI	Call TI
SN74BCT533DWR	OBSOLETE	SOIC	DW	20	TBD	Call TI	Call TI
SN74BCT533N	OBSOLETE	PDIP	N	20	TBD	Call TI	Call TI

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products Amplifiers amplifier.ti.com Data Converters dataconverter.ti.com DSP dsp.ti.com Clocks and Timers www.ti.com/clocks Interface interface.ti.com Logic logic.ti.com Power Mgmt power.ti.com Microcontrollers microcontroller.ti.com www.ti-rfid.com RF/IF and ZigBee® Solutions www.ti.com/lprf

Applications	
Audio	www.ti.com/audio
Automotive	www.ti.com/automotive
Broadband	www.ti.com/broadband
Digital Control	www.ti.com/digitalcontrol
Medical	www.ti.com/medical
Military	www.ti.com/military
Optical Networking	www.ti.com/opticalnetwork
Security	www.ti.com/security
Telephony	www.ti.com/telephony
Video & Imaging	www.ti.com/video
Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2008, Texas Instruments Incorporated